

## T-1 (3mm) RIGHT ANGLE LED INDICATOR

Part Number: WP934RS/SRD Super Bright Red

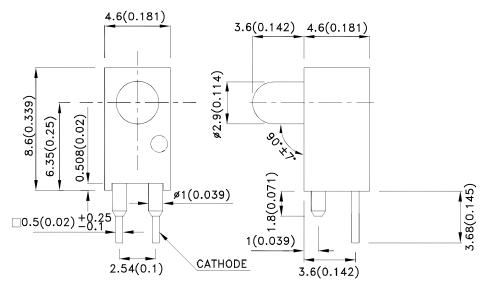
### **Features**

- Pre-trimmed leads for pc mounting.
- Pillars are designed for positioning the housing on P.C. board.
- Black case enhances contrast ratio.
- Wide viewing angle.
- · High reliability life measured in years.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

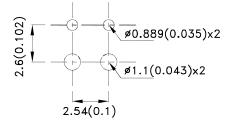
## Description

The Super Bright Red source color devices are made with Gallium Aluminum Arsenide Red Light Emitting Diode.

## **Package Dimensions**







### Notes:

- All dimensions are in millimeters (inches).
   Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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## **Selection Guide**

| Part No.    | Dice                      | lv (mcd) [2] Dice Lens Type @ 20mA |      |      | Viewing<br>Angle [1] |
|-------------|---------------------------|------------------------------------|------|------|----------------------|
|             |                           | -                                  | Min. | Тур. | 201/2                |
| WP934RS/SRD | Super Bright Red (GaAlAs) | Red Diffused                       | 150  | 400  | 40°                  |
|             |                           |                                    | *50  | *100 |                      |

- $1.\,\theta1$  / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
- 2. Luminous intensity / luminous Flux: + / -15%.

  \* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter                | Device           | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|------------------|------|------|-------|-----------------|
| λpeak  | Peak Wavelength          | Super Bright Red | 655  |      | nm    | IF=20mA         |
| λD [1] | Dominant Wavelength      | Super Bright Red | 640  |      | nm    | IF=20mA         |
| Δλ1/2  | Spectral Line Half-width | Super Bright Red | 20   |      | nm    | IF=20mA         |
| С      | Capacitance              | Super Bright Red | 45   |      | pF    | VF=0V;f=1MHz    |
| VF [2] | Forward Voltage          | Super Bright Red | 1.85 | 2.5  | V     | IF=20mA         |
| lr     | Reverse Current          | Super Bright Red |      | 10   | uA    | VR = 5V         |

- Notes:
  1. Wavelength: + / -1nm.
  2. Forward Voltage: + / -0.1V.
  3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

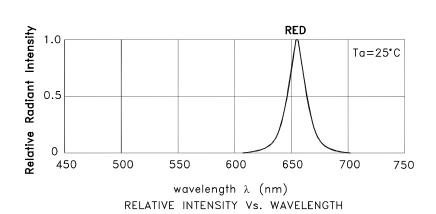
## Absolute Maximum Ratings at TA=25°C

| Parameter                     | Super Bright Red    | Units |  |
|-------------------------------|---------------------|-------|--|
| Power dissipation             | 75                  | mW    |  |
| DC Forward Current            | 30                  | mA    |  |
| Peak Forward Current [1]      | 155                 | mA    |  |
| Reverse Voltage               | 5                   | V     |  |
| Operating/Storage Temperature | -40°C To +85°C      |       |  |
| Lead Solder Temperature [2]   | 260°C For 3 Seconds |       |  |
| Lead Solder Temperature [3]   | 260°C For 5 Seconds |       |  |

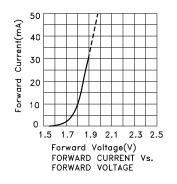
### Notes:

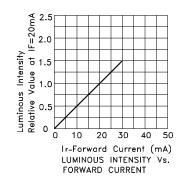
- 1. 1 / 10 Duty Cycle, 0.1ms Pulse Width.
- 2. 2mm below package base.
- 3. 5mm below package base.

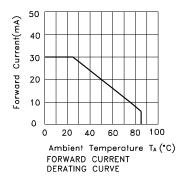
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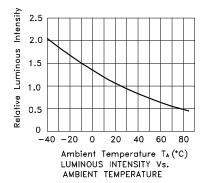


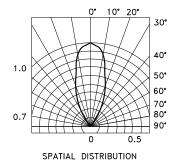
Super Bright Red WP934RS/SRD





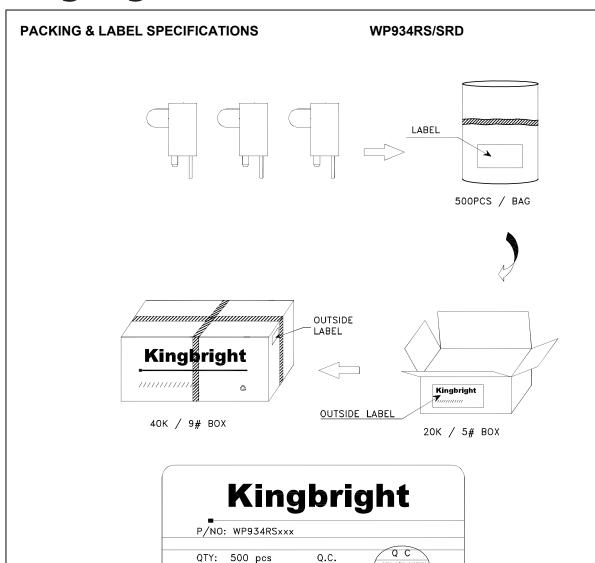






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S/N:

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1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.

xx xx xxxx

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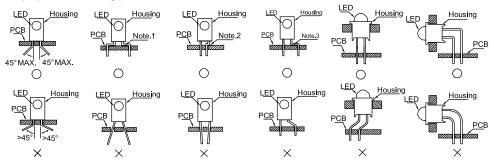
RoHS Compliant

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### **PRECAUTIONS**

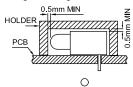
- 1. Storage conditions:
  - a. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
  - b.LEDs should be stored with temperature ≤30°C and relative humidity < 60%.
  - c.Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 ( $\pm$ 10/-0) hours at 85 ~ 100°C.
- 2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

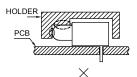


"  $\bigcirc$  " Correct mounting method "  $\times$  " Incorrect mounting method

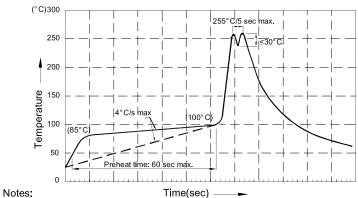
Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.





- 4. The tip of the soldering iron should never touch the lens epoxy.
- 5. Through-hole LEDs are incompatible with reflow soldering.
- 6. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 7. Recommended Wave Soldering Profiles:



- 1.Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2.Peak wave soldering temperature between 245° C ~ 255° C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C.
- 4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5.SAC 305 solder alloy is recommended.
- 6. No more than one wave soldering pass.

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